

Silicon Carbide Power Schottky Diode

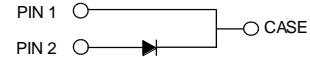
Features

- Industry's leading low leakage currents
- 175 °C maximum operating temperature
- Temperature independent switching behavior
- Superior surge current capability
- Positive temperature coefficient of V_F
- Extremely fast switching speeds
- Superior figure of merit Q_C/I_F

V_{RRM}	=	1200 V
$I_F (T_c = 25^\circ C)$	=	25 A
$I_F (T_c \leq 150^\circ C)$	=	10 A
Q_C	=	31 nC

Package

- RoHS Compliant



TO - 252

Advantages

- Low standby power losses
- Improved circuit efficiency (Lower overall cost)
- Low switching losses
- Ease of paralleling devices without thermal runaway
- Smaller heat sink requirements
- Low reverse recovery current
- Low device capacitance
- Low reverse leakage current at operating temperature

Applications

- Power Factor Correction (PFC)
- Switched-Mode Power Supply (SMPS)
- Solar Inverters
- Wind Turbine Inverters
- Motor Drives
- Induction Heating
- Uninterruptible Power Supply (UPS)
- High Voltage Multipliers

Maximum Ratings at $T_j = 175^\circ C$, unless otherwise specified

Parameter	Symbol	Conditions	Values	Unit
Repetitive peak reverse voltage	V_{RRM}		1200	V
Continuous forward current	I_F	$T_c = 25^\circ C$	25	A
Continuous forward current	I_F	$T_c \leq 150^\circ C$	10	A
RMS forward current	$I_{F(RMS)}$	$T_c \leq 150^\circ C$	17	A
Surge non-repetitive forward current, Half Sine Wave	$I_{F,SM}$	$T_c = 25^\circ C, t_p = 10\text{ ms}$ $T_c = 150^\circ C, t_p = 10\text{ ms}$	65 55	A
Non-repetitive peak forward current	$I_{F,max}$	$T_c = 25^\circ C, t_p = 10\text{ }\mu s$	280	A
I^2t value	$\int i^2 dt$	$T_c = 25^\circ C, t_p = 10\text{ ms}$ $T_c = 150^\circ C, t_p = 10\text{ ms}$	21 15	A^2s
Power dissipation	P_{tot}	$T_c = 25^\circ C$	190	W
Operating and storage temperature	T_j, T_{stg}		-55 to 175	°C

Electrical Characteristics at $T_j = 175^\circ C$, unless otherwise specified

Parameter	Symbol	Conditions	Values			Unit
			min.	typ.	max.	
Diode forward voltage	V_F	$I_F = 10\text{ A}, T_j = 25^\circ C$	1.5	1.8	2.6	V
		$I_F = 10\text{ A}, T_j = 175^\circ C$		3.0		
Reverse current	I_R	$V_R = 1200\text{ V}, T_j = 25^\circ C$	50	250	μA	
		$V_R = 1200\text{ V}, T_j = 175^\circ C$	100	500		
Total capacitive charge	Q_C	$I_F \leq I_{F,MAX}$ $dI_F/dt = 200\text{ A}/\mu s$ $T_j = 175^\circ C$	$V_R = 400\text{ V}$ $V_R = 960\text{ V}$	31 52		nC
Switching time	t_s		$V_R = 400\text{ V}$ $V_R = 960\text{ V}$	< 25		
Total capacitance	C	$V_R = 1\text{ V}, f = 1\text{ MHz}, T_j = 25^\circ C$ $V_R = 400\text{ V}, f = 1\text{ MHz}, T_j = 25^\circ C$ $V_R = 1000\text{ V}, f = 1\text{ MHz}, T_j = 25^\circ C$	490	45	pF	
			45	33		
			33			

Thermal Characteristics

Thermal resistance, junction - case	R_{thJC}	0.8	°C/W
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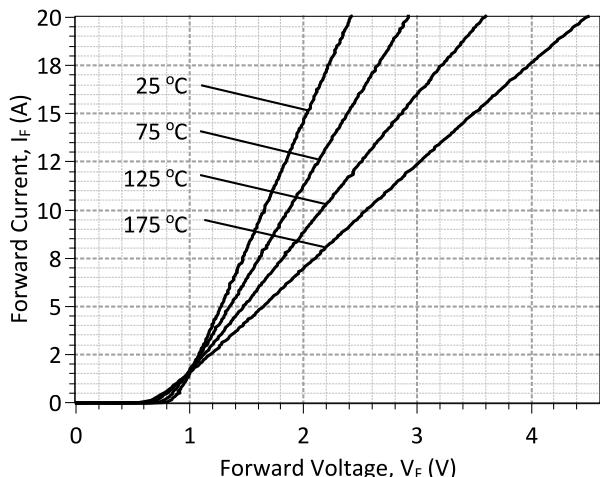


Figure 1: Typical Forward Characteristics

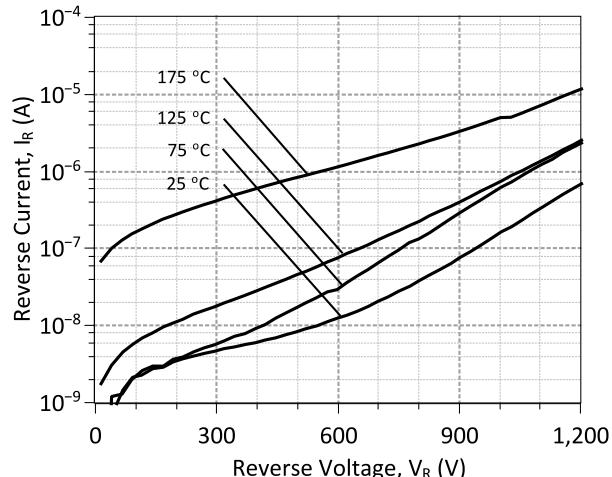


Figure 2: Typical Reverse Characteristics

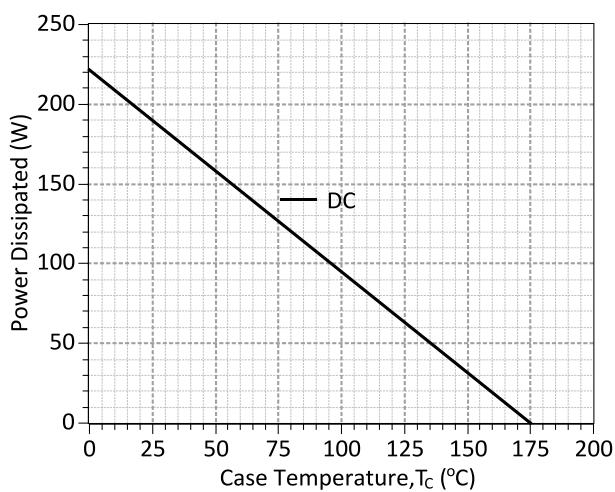


Figure 3: Power Derating Curve

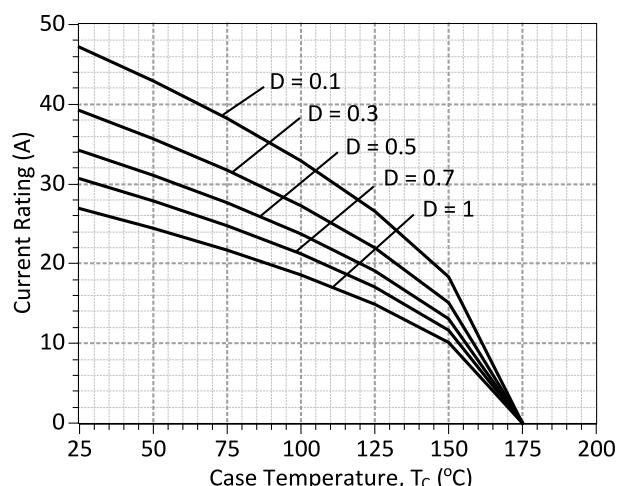


Figure 4: Current Derating Curves ($D = t_p/T$, $t_p = 400 \mu s$)
 (Considering worst case Z_{th} conditions)

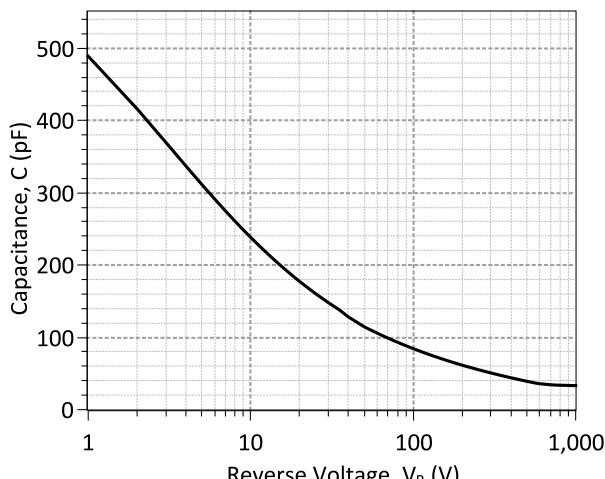


Figure 5: Typical Junction Capacitance vs Reverse Voltage Characteristics

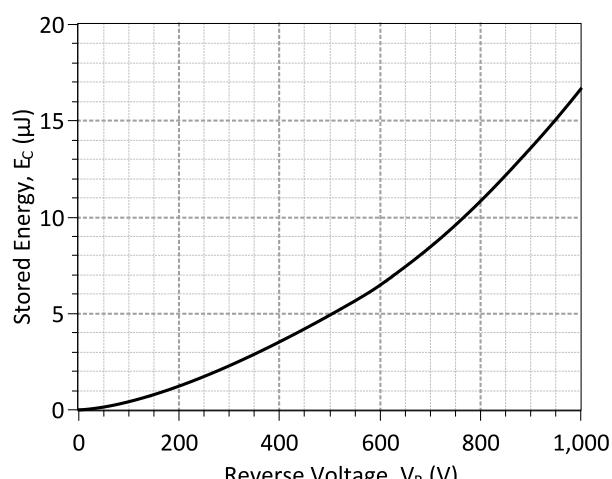


Figure 6: Typical Capacitive Energy vs Reverse Voltage Characteristics

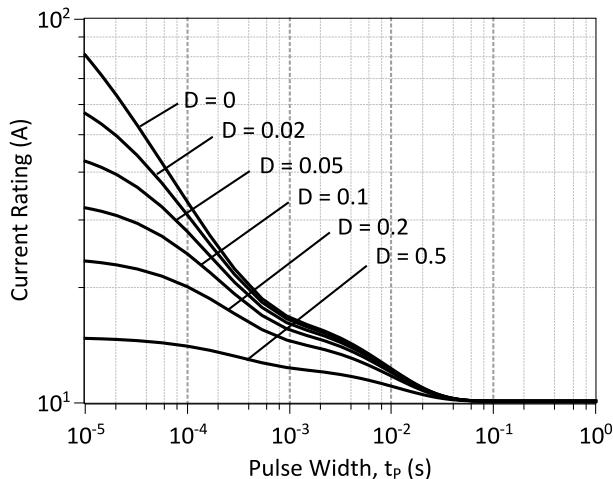


Figure 7: Current vs Pulse Duration Curves at $T_c = 150 \text{ } ^\circ\text{C}$

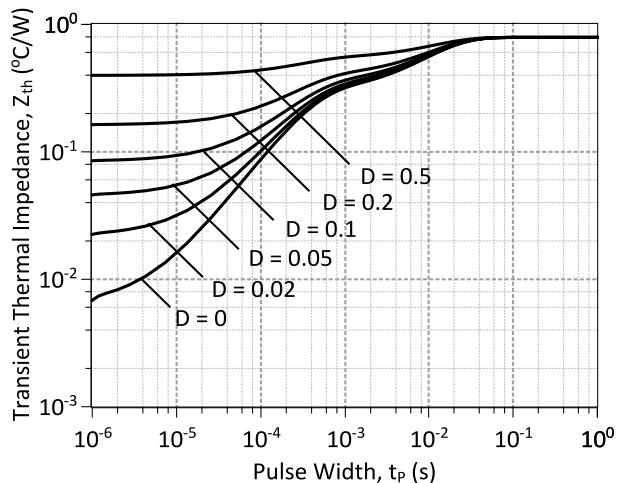
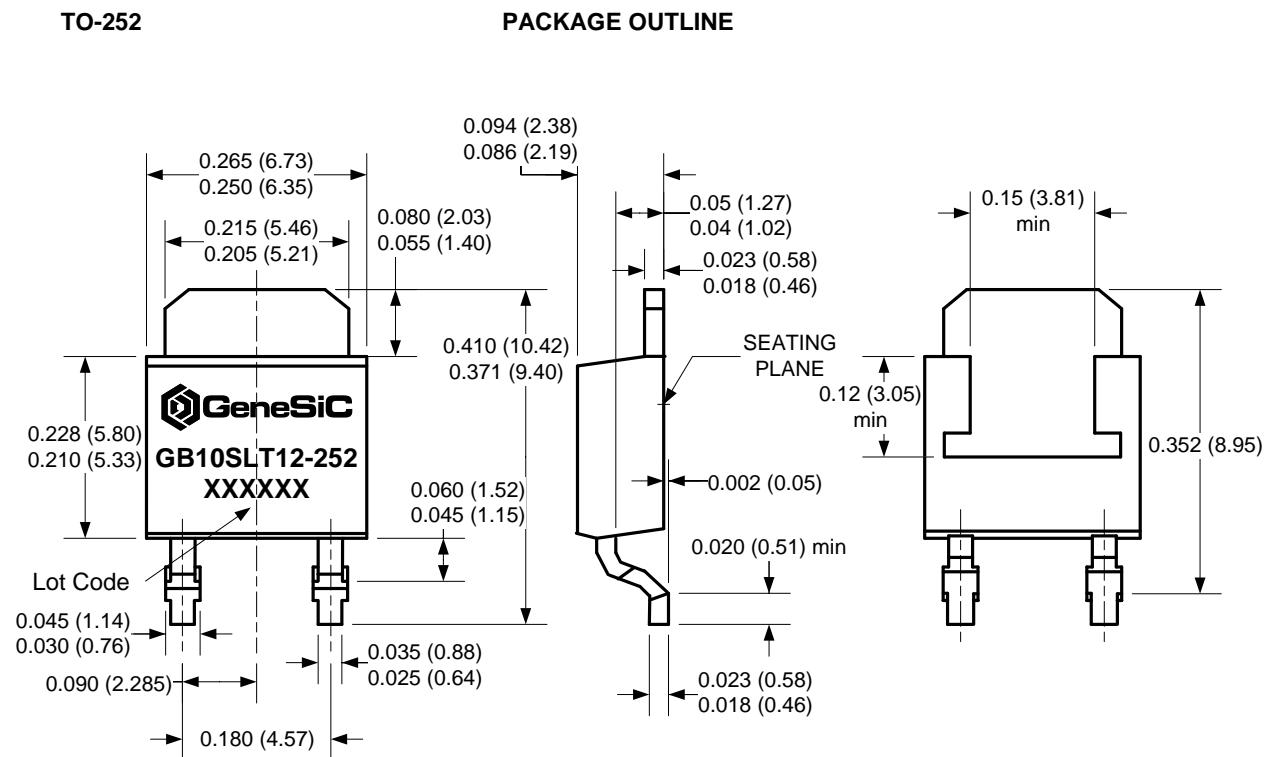


Figure 8: Transient Thermal Impedance

Package Dimensions:



NOTE

1. CONTROLLED DIMENSION IS INCH. DIMENSION IN BRACKET IS MILLIMETER.
2. DIMENSIONS DO NOT INCLUDE END FLASH, MOLD FLASH, MATERIAL PROTRUSIONS



GB10SLT12-252

Revision History			
Date	Revision	Comments	Supersedes
2014/08/26	4	Updated Electrical Characteristics	
2013/06/12	3	Updated Electrical Characteristics	
2012/12/18	2	Second generation update	
2012/05/22	1	Second generation release	
2010/12/14	0	Initial release	

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SPICE Model Parameters

This is a secure document. Please copy this code from the SPICE model PDF file on our website (http://www.genesicsemi.com/images/products_sic/rectifiers/GB10SLT12-252_SPICE.pdf) into LTSpice (version 4) software for simulation of the GB10SLT12-252.

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*      MODEL OF GeneSiC Semiconductor Inc.
*
*      $Revision:    1.0          $
*      $Date:      04-SEP-2013      $
*
*      GeneSiC Semiconductor Inc.
*      43670 Trade Center Place Ste. 155
*      Dulles, VA 20166
*
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*
* These models are provided "AS IS, WHERE IS, AND WITH NO WARRANTY
* OF ANY KIND EITHER EXPRESSED OR IMPLIED, INCLUDING BUT NOT LIMITED
* TO ANY IMPLIED WARRANTIES OF MERCHANTABILITY AND FITNESS FOR A
* PARTICULAR PURPOSE."
* Models accurate up to 2 times rated drain current.
*
* Start of GB10SLT12-252 SPICE Model
*
.SUBCKT GB10SLT12 ANODE KATHODE
D1 ANODE KATHODE GB10SLT12_SCHOTTKY
D2 ANODE KATHODE GB10SLT12_PIN
.MODEL GB10SLT12_SCHOTTKY D
+ IS      4.55E-15      RS      0.0736
+ N       1              IKF     1000
+ EG      1.2            XTI     -2
+ TRS1    0.0054347826  TRS2    2.71739E-05
+ CJO     6.40E-10      VJ      0.469
+ M       1.508          FC      0.5
+ TT      1.00E-10      BV      1200
+ IBV    1.00E-03      VPK     1200
+ IAVE    10             TYPE    Sic_Schottky
+ MFG    GeneSiC_Semi
.MODEL GB10SLT12_PIN D
+ IS      1.54E-22      RS      0.19
+ TRS1   -0.004         N       3.941
+ EG      3.23           IKF     19
+ XTI     0              FC      0.5
+ TT      0              BV      1200
+ IBV    1.00E-03      VPK     1200
+ IAVE    10             TYPE    Sic_PiN
.ENDS
*
* End of GB10SLT12-252 SPICE Model
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